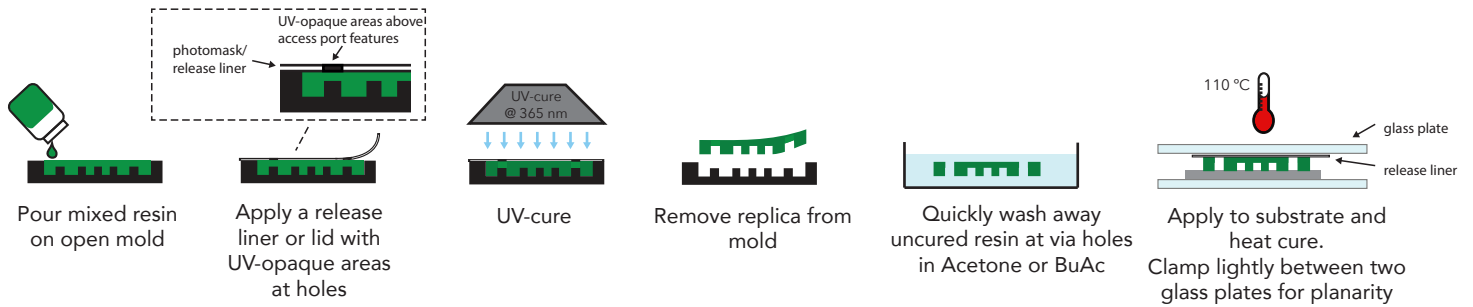


ostemer - Making fluidic ports

Three techniques for making vias holes

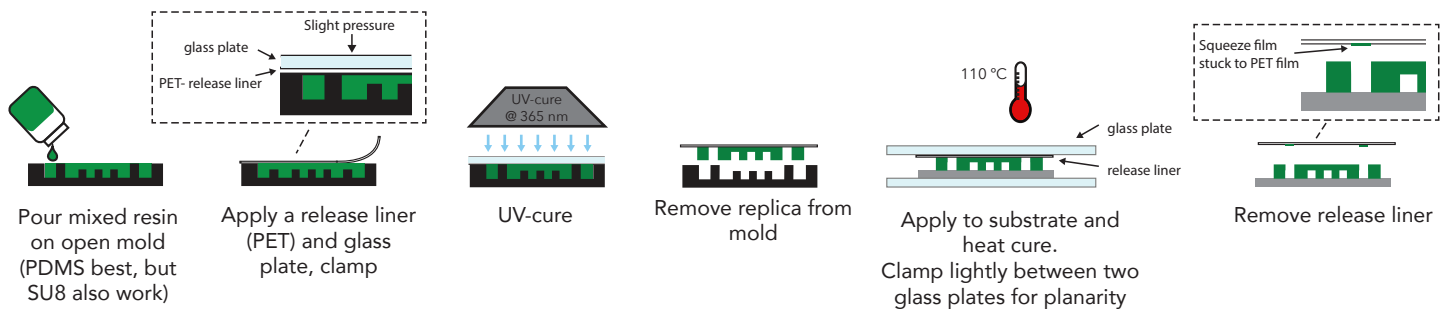
Photopatterning of vias

- + For one-level molds
- Requires alignment of mask
- Requires a development step to remove uncured resin



Two-level mold vias

- + Good when having many smaller vias
- Requires a two-level mold



Drilling in fully cured layer and laminate

- + Doesn't require two-layer molds
- Requires two Ostemer layers

